Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2012. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

 It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

 Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

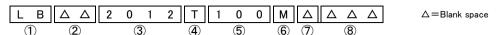
WIRE-WOUND CHIP INDUCTORS (LB SERIES)





REFLOW

■PARTS NUMBER



①Series name

Code	Series name
LB	Wound chip inductor

2Characteristics

Code	Characteristic
ΔΔ	Standard
ΔC	High current
ΔR	Low Rdc
MF	Low loss

③Dimensions (L × W)

Code	Type(inch)	Dimensions (L×W)[mm]
1608	1608 (0603)	1.6 × 0.8
2012	2012 (0805)	2.0 × 1.25
2016	2016 (0806)	2.0 × 1.6
2518	2518(1007)	2.5 × 1.8
3218	3218(1207)	3.2 × 1.8
3225	3225(1210)	3.2 × 2.5

4 Packaging

O	
Code	Packaging
Т	Taping

⑤Nominal inductance

Code (example)	Nominal inductance[μH]
1R0	1.0
100	10
101	100

※R=Decimal point

6 Inductance tolerance

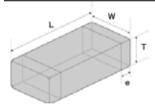
Code	Inductance tolerance				
K	±10%				
М	±20%				

7)Special code

Code Special code				
Δ	Standard			
R	Low Rdc type			

8Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

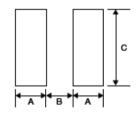


Туре		W	Т		Standard qu	antity [pcs]
Туре	L	VV		е	Paper tape	Embossed tape
LB 1608	1.6±0.1 (0.063±0.004)	0.8 ± 0.1 (0.031±0.004)	0.8 ± 0.1 (0.031±0.004)	0.35±0.15 (0.014±0.006)	4000	_
LMF1608	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.45±0.15 (0.016±0.006)	_	3000
LB 2012 LB C2012 LB R2012	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	1.25±0.2 (0.049±0.008)	0.5±0.2 (0.020±0.008)	_	3000
LB 2016 LB C2016	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.2 (0.020±0.008)	_	2000
LB 2518 LB C2518 LB R2518	2.5±0.2 (0.098±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.5±0.2 (0.020±0.008)	_	2000
LB 3218	3.2±0.2 (0.128±0.008)	1.8±0.2 (0.071±0.008)	1.8±0.2 (0.071±0.008)	0.6±0.2 (0.024±0.008)	-	2000
LB C3225	3.2±0.2 (0.128±0.008)	2.5±0.2 (0.098±0.008)	2.5±0.2 (0.098±0.008)	0.6±0.3 (0.024±0.012)	_	1000

Recommended Land Patterns

Surface Mounting

- •Mounting and soldering conditions should be checked beforehand.
- Applicable soldering process to these products is reflow soldering only.



		Offic. IIII	I (IIICII)
Туре	Α	В	С
1608	0.55	0.7	0.9
MF1608	0.55	0.7	1.0
2012	0.60	1.0	1.45
2016	0.60	1.0	1.8
2518	0.60	1.5	2.0
3218	0.85	1.7	2.0
3225	0.85	1.7	2.7
·			1.1. 24

Unit:mm

Unit:mm(inch)

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●1608(0603)type

Parts number	EHS	Nominal inductance $[\mu H]$	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB 1608T1R0M	RoHS	1.0	±20%	100	0.17	160	7.96
LB 1608T2R2M	RoHS	2.2	±20%	80	0.33	115	7.96
LB 1608T4R7M	RoHS	4.7	±20%	45	0.55	70	7.96
LB 1608T8R2M	RoHS	8.2	±20%	32	0.70	60	2.52
LB 1608T100M	RoHS	10	±20%	32	0.70	60	2.52

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LBMF1608T1R0M	RoHS	1.0	±20%	100	0.09	230	7.96
LBMF1608T2R2M	RoHS	2.2	±20%	80	0.17	160	7.96
LBMF1608T3R3M	RoHS	3.3	±20%	60	0.22	130	7.96
LBMF1608T4R7M	RoHS	4.7	±20%	45	0.24	110	7.96
LBMF1608T100[]	RoHS	10	±10%, ±20%	32	0.36	80	2.52
LBMF1608T220[]	RoHS	22	±10%, ±20%	16	1.0	50	2.52
LBMF1608T470[]	RoHS	47	±10%, ±20%	11	2.5	35	2.52

2012(0805)type

Parts number	EHS	Nominal inductance $[\mu H]$	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]
LB 2012T1R0M	RoHS	1.0	±20%	100	0.15	405	7.96
LB 2012T2R2M	RoHS	2.2	±20%	80	0.23	260	7.96
LB 2012T3R3M	RoHS	3.3	±20%	55	0.30	235	7.96
LB 2012T4R7M	RoHS	4.7	±20%	45	0.40	190	7.96
LB 2012T6R8M	RoHS	6.8	±20%	38	0.47	135	7.96
LB 2012T100[]	RoHS	10	±10%, ±20%	32	0.70	120	2.52
LB 2012T100□R	RoHS	10	±10%, ±20%	32	0.50	120	2.52
LB 2012T150[]	RoHS	15	±10%, ±20%	28	1.3	100	2.52
LB 2012T220[]	RoHS	22	±10%, ±20%	16	1.7	80	2.52
LB 2012T470[]	RoHS	47	±10%, ±20%	11	3.7	60	2.52
LB 2012T680[]	RoHS	68	±10%, ±20%	10	6.0	50	2.52
LB 2012T101[]	RoHS	100	±10%, ±20%	8	7.0	45	0.796

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB C2012T1R0M	RoHS	1.0	±20%	100	0.19	620	7.96
LB C2012T2R2M	RoHS	2.2	±20%	70	0.33	430	7.96
LB C2012T4R7M	RoHS	4.7	±20%	45	0.50	295	7.96
LB C2012T100[]	RoHS	10	±10%, ±20%	40	1.2	200	2.52
LB C2012T220[]	RoHS	22	±10%, ±20%	16	3.7	130	2.52
LB C2012T470[]	RoHS	47	±10%, ±20%	11	5.8	90	2.52

Parts number	EHS	Nominal inductance $[\mu H]$	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance $[\Omega](\pm 30\%)$	Rated current [mA] (max.)	Measuring frequency [MHz]
LB R2012T1R0M	RoHS	1.0	±20%	100	0.07	400	7.96
LB R2012T2R2M	RoHS	2.2	±20%	80	0.13	260	7.96
LB R2012T4R7M	RoHS	4.7	±20%	45	0.24	200	7.96
LB R2012T100[]	RoHS	10	±10%, ±20%	32	0.36	150	2.52
LB R2012T220[]	RoHS	22	±10%, ±20%	16	1.0	100	2.52
LB R2012T470[]	RoHS	47	±10%, ±20%	11	1.7	75	2.52
LB R2012T101[]	RoHS	100	±10%, ±20%	8	4.0	50	0.796

2016(0806)type

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB 2016T1R0M	RoHS	1.0	±20%	100	0.09	490	7.96
LB 2016T1R5M	RoHS	1.5	±20%	80	0.11	380	7.96
LB 2016T2R2M	RoHS	2.2	±20%	70	0.13	375	7.96
LB 2016T3R3M	RoHS	3.3	±20%	55	0.20	285	7.96
LB 2016T4R7M	RoHS	4.7	±20%	45	0.25	225	7.96
LB 2016T6R8M	RoHS	6.8	±20%	38	0.35	200	7.96
LB 2016T100[]	RoHS	10	±10%, ±20%	32	0.50	155	2.52
LB 2016T150[]	RoHS	15	±10%, ±20%	28	0.70	130	2.52
LB 2016T220[]	RoHS	22	±10%, ±20%	16	1.0	105	2.52
LB 2016T330[]	RoHS	33	±10%, ±20%	14	1.7	85	2.52
LB 2016T470[]	RoHS	47	±10%, ±20%	11	2.4	70	2.52
LB 2016T680[]	RoHS	68	±10%, ±20%	10	3.0	55	2.52
LB 2016T101[]	RoHS	100	±10%, ±20%	8	4.5	40	0.796

Parts number	EHS	Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current	Measuring frequency
		[µH]		[MHZ] (MIN.)	[公](王30%)	[mA] (max.)	[MHZ]
LB C2016T1R0M	R₀HS	1.0	±20%	100	0.10	690	7.96
LB C2016T1R5M	RoHS	1.5	±20%	80	0.15	600	7.96
LB C2016T2R2M	RoHS	2.2	±20%	70	0.20	520	7.96
LB C2016T3R3M	RoHS	3.3	±20%	55	0.27	410	7.96
LB C2016T4R7M	RoHS	4.7	±20%	45	0.37	355	7.96
LB C2016T6R8M	RoHS	6.8	±20%	38	0.59	290	7.96
LB C2016T100[]	RoHS	10	±10%, ±20%	32	0.82	245	2.52
LB C2016T150[]	RoHS	15	±10%, ±20%	28	1.2	200	2.52
LB C2016T220[]	RoHS	22	±10%, ±20%	16	1.8	165	2.52
LB C2016T330[]	RoHS	33	±10%, ±20%	14	2.8	135	2.52
LB C2016T470[]	RoHS	47	±10%, ±20%	11	4.3	110	2.52
LB C2016T680[]	RoHS	68	±10%, ±20%	10	7.0	95	2.52
LB C2016T101[]	RoHS	100	±10%, ±20%	8	8.0	75	0.796

^{· ☐} Please specify the Inductance tolerance code (K or M)

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2518(1007) type

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB 2518T1R0M	RoHS	1.0	±20%	100	0.06	665	7.96
LB 2518T1R5M	RoHS	1.5	±20%	80	0.07	405	7.96
LB 2518T2R2M	RoHS	2.2	±20%	68	0.09	340	7.96
LB 2518T3R3M	RoHS	3.3	±20%	54	0.11	280	7.96
LB 2518T4R7M	RoHS	4.7	±20%	46	0.13	240	7.96
LB 2518T4R7MR	RoHS	4.7	±20%	46	0.10	235	7.96
LB 2518T6R8M	RoHS	6.8	±20%	38	0.15	195	7.96
LB 2518T100[]	RoHS	10	±10%, ±20%	30	0.25	165	2.52
LB 2518T150[]	RoHS	15	±10%, ±20%	23	0.32	145	2.52
LB 2518T220[]	RoHS	22	±10%, ±20%	19	0.50	115	2.52
LB 2518T330[]	RoHS	33	±10%, ±20%	15	0.70	95	2.52
LB 2518T470[]	RoHS	47	±10%, ±20%	12	0.95	85	2.52
LB 2518T680[]	RoHS	68	±10%, ±20%	9.5	1.5	70	2.52
LB 2518T101[]	RoHS	100	±10%, ±20%	9.0	2.1	60	0.796
LB 2518T151[]	RoHS	150	±10%, ±20%	7.0	3.2	45	0.796
LB 2518T221[]	RoHS	220	±10%, ±20%	5.5	4.5	40	0.796
LB 2518T331[]	RoHS	330	±10%, ±20%	4.5	7.0	30	0.796
LB 2518T471[]	RoHS	470	±10%, ±20%	3.5	10	25	0.796
LB 2518T681[]	RoHS	680	±10%, ±20%	3.0	17	20	0.796
LB 2518T102[]	RoHS	1000	±10%, ±20%	2.4	24	15	0.252

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB C2518T1R0M	RoHS	1.0	±20%	100	0.08	775	7.96
LB C2518T1R0MR	RoHS	1.0	±20%	100	0.07	890	7.96
LB C2518T1R5M	RoHS	1.5	±20%	80	0.11	730	7.96
LB C2518T2R2M	RoHS	2.2	±20%	68	0.13	630	7.96
LB C2518T3R3M	RoHS	3.3	±20%	54	0.16	560	7.96
LB C2518T4R7M	RoHS	4.7	±20%	41	0.20	510	7.96
LB C2518T6R8M	RoHS	6.8	±20%	38	0.30	420	7.96
LB C2518T100[]	RoHS	10	±10%, ±20%	30	0.36	375	2.52
LB C2518T150[]	RoHS	15	±10%, ±20%	23	0.65	285	2.52
LB C2518T220[]	RoHS	22	±10%, ±20%	19	0.77	250	2.52
LB C2518T330[]	RoHS	33	±10%, ±20%	15	1.5	185	2.52
LB C2518T470[]	RoHS	47	±10%, ±20%	12	1.9	165	2.52
LB C2518T680[]	RoHS	68	±10%, ±20%	9.5	2.8	140	2.52
LB C2518T101[]	RoHS	100	±10%, ±20%	9.0	3.7	125	0.796
LB C2518T151[]	RoHS	150	±10%, ±20%	7.0	6.1	95	0.796
LB C2518T221[]	RoHS	220	±10%, ±20%	5.5	8.4	80	0.796
LB C2518T331[]	RoHS	330	±10%, ±20%	4.5	12.3	65	0.796
LB C2518T471[]	RoHS	470	±10%, ±20%	3.5	22	50	0.796
LB C2518T681□	RoHS	680	±10%, ±20%	3.0	28	45	0.796

Parts number	EHS	Nominal inductance $[\mu H]$	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB R2518T1R0M	RoHS	1.0	±20%	100	0.045	960	7.96
LB R2518T2R2M	RoHS	2.2	±20%	68	0.07	480	7.96
LB R2518T4R7M	R₀HS	4.7	±20%	45	0.10	345	7.96
LB R2518T100[]	RoHS	10	±10%, ±20%	30	0.19	235	2.52
LB R2518T220[]	RoHS	22	±10%, ±20%	19	0.44	175	2.52
LB R2518T470[]	RoHS	47	±10%, ±20%	11	0.84	120	2.52
LB R2518T101[]	R₀HS	100	±10%, ±20%	9	1.89	80	0.796

3218(1297)type

3218(1297)type							
Parts number	EHS	Nominal inductance [μ Η]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB 3218T1R0M	RoHS	1.0	±20%	100	0.06	1,075	7.96
LB 3218T1R5M	RoHS	1.5	±20%	80	0.07	860	7.96
LB 3218T2R2M	RoHS	2.2	±20%	68	0.09	775	7.96
LB 3218T3R3M	RoHS	3.3	±20%	54	0.11	560	7.96
LB 3218T4R7M	RoHS	4.7	±20%	41	0.13	550	7.96
LB 3218T6R8M	RoHS	6.8	±20%	40	0.17	380	7.96
LB 3218T100[]	RoHS	10	±10%, ±20%	30	0.25	340	2.52
LB 3218T150[]	RoHS	15	±10%, ±20%	25	0.32	300	2.52
LB 3218T220[]	RoHS	22	±10%, ±20%	19	0.49	255	2.52
LB 3218T330[]	RoHS	33	±10%, ±20%	15	0.75	215	2.52
LB 3218T470[]	RoHS	47	±10%, ±20%	12	0.92	205	2.52
LB 3218T680[]	RoHS	68	±10%, ±20%	11	1.49	145	2.52
LB 3218T101[]	RoHS	100	±10%, ±20%	8.0	2.4	140	0.796
LB 3218T151[]	RoHS	150	±10%, ±20%	7.0	3.2	105	0.796
LB 3218T221[]	RoHS	220	±10%, ±20%	5.0	5.4	80	0.796
LB 3218T331[]	RoHS	330	±10%, ±20%	4.0	7.0	65	0.796
LB 3218T471[]	RoHS	470	±10%, ±20%	3.5	14	54	0.796
LB 3218T681[]	RoHS	680	±10%, ±20%	3.0	17	45	0.796
LB 3218T102[]	RoHS	1000	±10%, ±20%	2.4	27	39	0.252

[•]Please specify the Inductance tolerance code (K or M)

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3225(121<u>0</u>)type

Parts number	EHS	Nominal inductance $[\mu H]$	Inductance tolerance	Self-resonant frequency [MHz](min.)	DC Resistance [Ω](±30%)	Rated current [mA] (max.)	Measuring frequency [MHz]
LB C3225T1R0MR	RoHS	1.0	±20%	250	0.055	1,100	0.1
LB C3225T1R5MR	RoHS	1.5	±20%	220	0.060	1,000	0.1
LB C3225T2R2MR	RoHS	2.2	±20%	190	0.080	930	0.1
LB C3225T3R3MR	RoHS	3.3	±20%	160	0.095	820	0.1
LB C3225T4R7MR	RoHS	4.7	±20%	70	0.100	680	0.1
LB C3225T6R8MR	RoHS	6.8	±20%	50	0.120	620	0.1
LB C3225T100□R	RoHS	10	±10%, ±20%	23	0.133	540	0.1
LB C3225T150□R	RoHS	15	±10%, ±20%	20	0.195	420	0.1
LB C3225T220□R	RoHS	22	±10%, ±20%	17	0.27	330	0.1
LB C3225T330□R	RoHS	33	±10%, ±20%	13	0.41	300	0.1
LB C3225T470□R	RoHS	47	±10%, ±20%	10	0.67	220	0.1
LB C3225T680∏R	RoHS	68	±10%, ±20%	8	1.0	190	0.1
LB C3225T101□R	RoHS	100	±10%, ±20%	6	1.4	150	0.1

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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

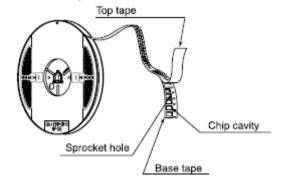
PACKAGING

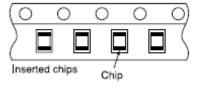
1 Minimum Quantity

Turne	Standard Qu	antity [pcs]	
Туре	Paper Tape	Embossed Tape	
LB C3225	_	1000	
CB C3225		1000	
LB 3218	_	2000	
LB R2518			
LB C2518			
LB 2518	_	2000	
CB 2518			
CB C2518			
LBM2016			
LB C2016			
LB 2016	_	2000	
CB 2016			
CB C2016			
LB 2012			
LB C2012			
LB R2012	_	3000	
CB 2012			
CB C2012			
CB L2012	4000	_	
LB 1608	4000	_	
LBMF1608	_	3000	
CBMF1608		3000	

②Tape material

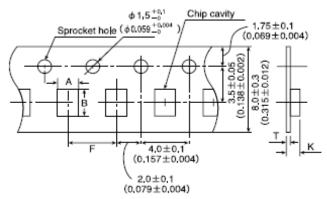
Embossed tape





3Taping Dimensions

- Embossed Tape (0.315 inches wide)
- Card board carrier tape (0.315 inches wide)

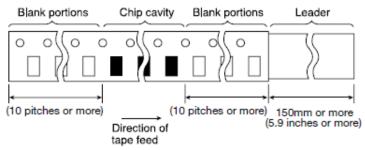


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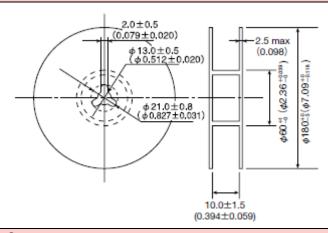
T	Chip	cavity	Insertion pitch	Tape th	ickness
Туре	Α	В	F	Т	K
LBM2016	1.75±0.1 (0.069±0.004)	2.1 ± 0.1 (0.083 \pm 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB C3225 CB C3225	2.8±0.1 (0.110±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	4.0max. (0.157max.)
LB 3218	2.1±0.1 (0.083±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2518 CB 2518 LB C2518 CB C2518 LB R2518	2.15±0.1 (0.085±0.004)	2.7±0.1 (0.106±0.004)	4.0±0.1 (0.157±0.004)	0.3±0.05 (0.012±0.002)	2.2max. (0.087max.)
LB 2016 CB 2016 LB C2016 CB C2016	1.75±0.1 (0.069±0.004)	2.1±0.1 (0.083±0.004)	4.0±0.1 (0.157±.004)	0.3±0.05 (0.012±0.002)	1.9max. (0.075max.)
LB 2012 CB 2012 LB C2012 CB C2012 LB R2012	1.45±0.1 (0.057±0.004)	2.25±0.1 (0.089±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.45max. (0.057max.)
CB L2012	1.55±0.1 (0.061±0.004)	2.3 ± 0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)	1.1max. (0.043max.)
LB 1608	1.0±0.1 (0.039±0.004)	1.8±0.1 (0.071±0.004)	4.0±0.1 (0.157±0.004)	1.1max. (0.043max.)	1.1max. (0.043max.)
LBMF1608 CBMF1608	1.1±0.1 (0.043±0.004)	1.9±0.1 (0.075±0.004)	4.0±0.1 (0.157±0.004)	0.25±0.05 (0.010±0.002)	1.2max. (0.047max.)

Unit:mm(inch)

4 Leader and Blank Portion

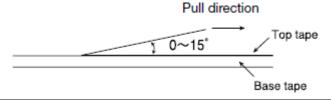


⑤Reel Size



©Top Tape Strength

The top tape requires a peel-off force 0.2 to 0.7N in the direction of the arrow as illustrated below.



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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

■RELIABILITY DATA

	LBC, LBR, LBMF Series CBC, CBL, CBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series						
		40 1 40500 /* 1 11 15					
LBM	A Cardan	-40~+105°C (Including self-generated heat)					
	vi Series						
2. Storage Temperature F	Range (after soldering)						
LB, I	LBC, LBR, LBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series	-40~+85°C					
LBM	// Series						
Test Methods and LB.	CB Series:						
Remarks Plea	ase refer the term of \H 7. storage conditions \H in precautions	5.					
<u> </u>							
3.Rated Current							
LB,	LBC, LBR, LBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance					
LBM	// Series	1					
4.Inductance							
	LBC, LBR, LBMF Series						
	CBC, CBL, CBMF Series	Within the specified tolerance					
	M Series	The specified colorande					
	LB·LBC·LBR·CB·CBC·CBL·LBMF·CBMF·LBM Series						
-							
5.Q							
LB,	LBC, LBR, LBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series	_					
LBM	M Series	Within the specified tolerance					
Test Methods and LBM	M Series						
Remarks Me	easuring equipment : LCR Mater(HP4285A or its equ	uivalent)					
6.DC Resisitance							
LB,	LBC, LBR, LBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance					
LBM	// Series						
Test Methods and Remarks	asuring equipment : DC Ohmmeter (HIOKI 3227 or its equiv	valent)					
7.Self-Resonant Frequence	icy						
LB,	LBC, LBR, LBMF Series						
Specified Value CB,	CBC, CBL, CBMF Series	Within the specified tolerance					
LBM	M Series						
Test Methods and Remarks	asuring equipment : Impedance analyzer(HP4291A or its e	quivalent)					

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8.Temperature Characteristic LBM2016 Inductance change: Within ±5% LB1608 LB2012 LBR2012 CB2012 Inductance change: Within ± 20% CBL2012 LB2016 CB2016 LB2518 Specified Value LBR2518 CB2518 LBC3225 CBC3225 CBMF1608 Inductance change : Within $\pm 25\%$ LBMF1608 LBC2016 CBC2016 LBC2518 CBC2518 LB3218 LBC2012 CBC2012 Inductance change: Within ±35% Test Methods and Change of maximum inductance deviation in step 1-5 Remarks Temperature (°C) Step LB, CB Series 20 2 **-40** 3 20 (Reference temperature) 4 +85 (Maximum operating temperature) 5 20

9.Rasistance to Flex	xure of Substrate	
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	No damage.
	LBM Series	
Test Methods and Remarks	Warp : 2mm(LB·LBC·LBR·CB·CBC·CBL·LBM·L Test substrate : Board according to JIS C0051 Thickness : 0.8mm(LB·LBMF·CBMF1608) : 1.0mm(Others) Pressing jig 10 20 10 R5 45±2mm 45±2mm 45±2mm	BMF•CBMF Series)

10.Body Strength		
	LB, LBC, LBR, LBMF Series	
Specified Value	CB, CBC, CBL, CBMF Series	No damage.
	LBM Series	
Test Methods and Remarks	LB·LBC·LBR·CB·CBC·CBL·LBM Applied force : 10N Duration : 10sec. LB1608·LBMF1608·CBMF1608 Applied force : 5N Duration : 10sec.	

11.Adhesion of tern	ninal electrode		
	LB, LBC, LBR, LBMF Series CB, CBC, CBL, CBMF Series		No abnormality.
Specified Value			
	LBM Series		
Test Methods and	LB·LBC·LBR·CB	·CBC·CBL·LBM·LBMF·CBMF	·
Remarks	Applied force	: 10N to X and Y directions	
	Duration	: 5 sec.	
	Test substrate	: Printed board	
	LB1608 • CBMF160	08 • LBMF1608	
	Applied force	: 5N toX and Y directions	
	Dration	: 5 sec.	
	Test substrate	: Printed board	

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	bration		
	LB, LBC, LBR, LBMF Se	ries	Inductance change : Within±10%
Specified Value	CB, CBC, CBL, CBMF Series		No significant abnormality in appearance.
Specifical Value	LBM Series		Inductance change: Within±5% No significant abnormality in appearance.
Test Methods and Remarks	Vibration type : A Directions : 2 hrs each in X, Y and Z directions. Freuency range : 10 to 55 to 10 Hz (1min.) Amplitude : 1.5mm Mounting method : Soldering onto printed board		
13.Drop test			
13.Drop test	LD LDO LDD LDME C-	4	
0 '6 11/1	LB, LBC, LBR, LBMF Se		-
Specified Value	CB, CBC, CBL, CBMF S	eries	
_	LBM Series		
1			
14.Solderability	T		1
	LB, LBC, LBR, LBMF Se		<u> </u>
Specified Value	CB, CBC, CBL, CBMF S	eries	At least 90% of surface of terminal electrode is covered by new
	LBM Series		
Test Methods and Remarks		·CBL·LBM·LBMF·CBMF: : 245±5°C : 5±0.5sec : Methanol solution with 25% of col	lophony
15.Resistance to so	oldering		
	LB, LBC, LBR, LBMF Se	ries	
Specified Value	CB, CBC, CBL, CBMF Se		Inductance change : Within±10%
oposmou valas	LBM Series	5.100	Industance change: Within + 504
	LBM Series Inductance change: Within±5% LB·LBC·LBR·CB·CBC·CBL·LBM·LBMF·CBMF: 3 times of reflow oven at 230°C MIN for 40sec. with peak temperature at 260 °C for 5sec.		
Test Methods and Remarks			
Remarks	3 times of reflow oven a		
	3 times of reflow oven a	at 230°C MIN for 40sec. with peak te	
Remarks 16.Resisitance to s	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.
Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se	at 230°C MIN for 40sec. with peak te	
Remarks 16.Resisitance to s	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.
Remarks 16.Resisitance to s Specified Value Test Methods and	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.
Remarks 16.Resisitance to s Specified Value Test Methods and	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent	at 230°C MIN for 40sec. with peak te	emperature at 260 °C for 5sec.
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent Cleaning conditions	at 230°C MIN for 40sec. with peak terries eries : Room temperature : Isopropyl alcohol : 90s. Immersion and cleaning.	emperature at 260 °C for 5sec.
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks 17.Thermal shock	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Sc LBM Series Solvent temperature Type of solvent Cleaning conditions LB, LBC, LBR, LBMF Se	at 230°C MIN for 40sec. with peak terries Pries Room temperature Isopropyl alcohol 90s. Immersion and cleaning.	Inductance change: Within±10%
Remarks 16.Resisitance to s Specified Value Test Methods and Remarks	3 times of reflow oven a colvent LB, LBC, LBR, LBMF Se CB, CBC, CBL, CBMF Se LBM Series Solvent temperature Type of solvent Cleaning conditions	at 230°C MIN for 40sec. with peak terries Pries Room temperature Isopropyl alcohol 90s. Immersion and cleaning.	Pemperature at 260 °C for 5sec. No significant abnormality in appearance

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18.Damp heat life to	est		
. J. Damp Hoat Ine te	I	MF Series	
Specified Value	LB, LBC, LBR, LBMF Series CB, CBC, CBL, CBMF Series		Inductance change : Within±10%
	LBM Series		No significant abnormality in appearance.
Test Methods and	Temperature	: 60±2°C	
Remarks	Humidity	: 90~95%RH	
	Duration	: 1000 hrs	
	Recovery	: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs.
19.Loading under da	amp heat life test		
	LB, LBC, LBR, LBI	MF Series	
	CB, CBC, CBL, CBMF Series		Inductance change: Within±10%
Specified Value	LBM Series		No significant abnormality in appearance.
Test Methods and	Temperature	: 60±2°C	<u> </u>
Remarks	Humidity	: 90~95%RH	
	Duration	: 1000 hrs	
	Applied current Recovery	: Rated current	er the standard condition after the test, followed by the measurement within 48 hrs.
	recovery	. At least 2 his of recovery und	of the standard condition arter the test, followed by the measurement within 40 ms.
20.High temperature	e life test		
	LB, LBC, LBR, LBI	MF Series	
Specified Value	CB, CBC, CBL, CE	BMF Series	Inductance change : Within±10% No significant abnormality in appearance.
	LBM Series		The digilillocate abtorniality in appearance.
Test Methods and	Temperature	: 85±2°C	
Remarks	Duration : 1000 hrs		
Remarks			or the standard condition after the test followed by the measurement within 48 hrs
Remarks	Recovery		er the standard condition after the test, followed by the measurement within 48 hrs.
	Recovery	: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs.
		: At least 2 hrs of recovery und	er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%
	Recovery	: At least 2 hrs of recovery und	
	Recovery emperature life test	: At least 2 hrs of recovery und	Inductance change : Within±10%
21.Loading at high t	Recovery emperature life test	: At least 2 hrs of recovery und	Inductance change : Within±10% (LBC3225 Series : Within±20%)
21.Loading at high t	emperature life test LB, LBC, LBR, LBI	: At least 2 hrs of recovery und	Inductance change : Within±10% (LBC3225 Series : Within±20%)
21.Loading at high t Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C	Inductance change : Within±10% (LBC3225 Series : Within±20%)
21.Loading at high t	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs	Inductance change : Within±10% (LBC3225 Series : Within±20%)
21.Loading at high t Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%) No significant abnormality in appearance.
21.Loading at high t Specified Value Test Methods and	Recovery Cemperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%)
21.Loading at high t Specified Value Test Methods and	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current	Inductance change : Within±10% (LBC3225 Series : Within±20%) No significant abnormality in appearance.
21.Loading at high to Specified Value Test Methods and Remarks	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. ———————————————————————————————————
21.Loading at high to Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%
21.Loading at high to Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI LB, LBC, LBR, LBI	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. ———————————————————————————————————
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series 3MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series 3MF Series : -40±2°C	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10%
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and	Recovery emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery e life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series BMF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series BMF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance.
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs.
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks 23.Standard conditions	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks	emperature life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery life test LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further measurement shall be had within the following limits:
21.Loading at high to Specified Value Test Methods and Remarks 22.Low temperature Specified Value Test Methods and Remarks 23.Standard conditions	Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Applied current Recovery LB, LBC, LBR, LBI CB, CBC, CBL, CE LBM Series Temperature Duration Recovery	: At least 2 hrs of recovery und MF Series : 85±2°C : 1000 hrs : Rated current : At least 2 hrs of recovery und MF Series MF Series : -40±2°C : 1000 hrs : At least 2 hrs of recovery und	Inductance change: Within±10% (LBC3225 Series: Within±20%) No significant abnormality in appearance. — er the standard condition after the test, followed by the measurement within 48 hrs. Inductance change: Within±10% No significant abnormality in appearance. er the standard condition after the test, followed by the measurement within 48 hrs. Standard condition after the test, followed by the measurement within 48 hrs. Unless specified, Ambient temperature is 20±15°C and the Relative humidity is 65±20%. If there is any doubt about the test results, further

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WIRE-WOUND CHIP INDUCTORS (LB SERIES), WIRE-WOUND CHIP POWER INDUCTORS (CB SERIES), WIRE-WOUND CHIP INDUCTORS FOR SIGNAL LINES (LB SERIES M TYPE)

PRECAUTIONS

1. Circuit Design

Precautions

Operating environment

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

2. PCB Design

Precautions

considerations

◆Land pattern design

1. Please contact any of our offices for a land pattern, and refer to a recommended land pattern of a right figure or specifications.

Technical

PRECAUTIONS

[Recommended Land Patterns]

Surface Mounting

- · Mounting and soldering conditions should be checked beforehand.
- · Applicable soldering process to those products is reflow soldering only.

3. Considerations for automatic placement

Precautions

◆Adjustment of mounting machine

- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

◆Reflow soldering(LB and CB Types)

Precautions

Technical

considerations

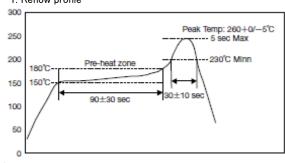
1. For reflow soldering with either leaded or lead-free solder, the profile specified in "point for controlling" is recommended.

◆Recommended conditions for using a soldering iron

1. Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration-3 seconds or less. The soldering iron should not come in contact with inductor directly.

◆Reflow soldering(LB and CB Types)

1. Reflow profile



- ◆Recommended conditions for using a soldering iron
- 1. Components can be damaged by excessive heat where soldering conditions exceed the specified range

5. Cleaning

Precautions

◆Cleaning conditions

Washing by supersonic waves shall be avoided.

Technical considerations

◆Cleaning conditions

If washed by supersonic waves, the products might be broken.

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

6. Handling	
Precautions	 ◆Handling 1. Keep the inductors away from all magnets and magnetic objects. ◆Breakaway PC boards(splitting along perforations) 1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations 1. Please do not give the inductors any excessive mechanical shocks.
Technical considerations	 ◆Handling 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards(splitting along perforations) 1. Planning pattern configurations and the position of products should be carefully performed to minimize stress. ◆Mechanical considerations 1. There is a case to be damaged by a mechanical shock.

Precautions	 ◆Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature:0~40°C / Humidity:Below 70% RH The ambient temperature must be kept below 30°C even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, LB type: Should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrode and deterioration of taping/packaging materials may take place.